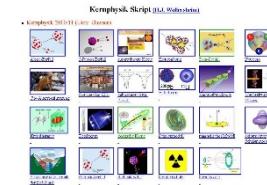


Outline: RISING – active stopper

Lecturer: Hans-Jürgen Wollersheim

e-mail: h.j.wollersheim@gsi.de

web-page: <https://web-docs.gsi.de/~wolle/> and click on



1. measurements with double-sided Si-strip detector
2. mesytec and multichannel systems electronics
3. ^{241}Am and ^{207}Bi source
4. implantation detector for RISING
5. experimental results

Active catcher for implantation-decay correlations

Implantation-decay correlations with large background
(half lifes similar to the implantation rate):

- ✓ implantation-decay time correlation: active catcher
- ✓ implantation-decay position correlation: granularity
- ✓ implantation of several ions: thickness and area
- ✓ energy of the implanted ion and the emitted β



3 double-sided silicon-strip detectors

- surface $5 \times 5 \text{ cm}^2$
- thickness 1 mm
- $2 \times 16 \text{ } 3.125 \text{ mm}$ strips
- manufactured by MICRON

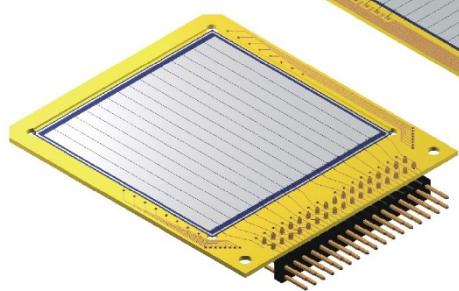


Measurements with a double-sided Si-strip detector 2006

Rear Ohmic Side



Front Junction Side



Micron Semiconductor

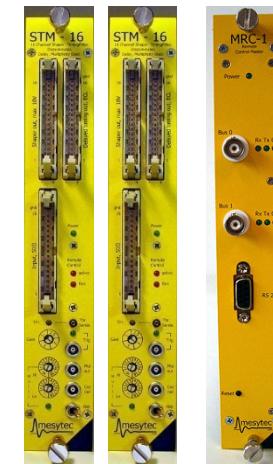
Nº Junction Elements:	16
Nº Junction Elements:	16
Element Length:	49.5 mm
Element Pitch:	3.1 mm
Element width:	3.0 mm
Active Area:	50x50 mm ²
Thickness:	1000 µm
Price:	5600 €



MPR-32 Charge Sensitive Preamplifier

32 channel compact module
Sensitivity switch, factor 5
Bias voltage up to $\pm 400V$

Price: 2790 €

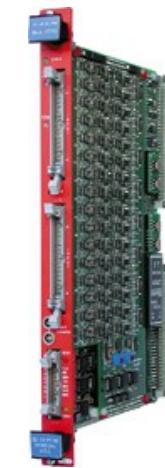


STM-16
16 fold shaper

16 channel NIM module
shaper amplifier
timing filter amplifier
leading edge discriminator

Price: 2x 3415 €

CAEN



ADC V785AF
32 channel

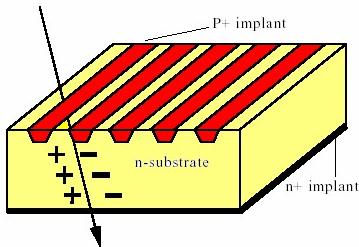
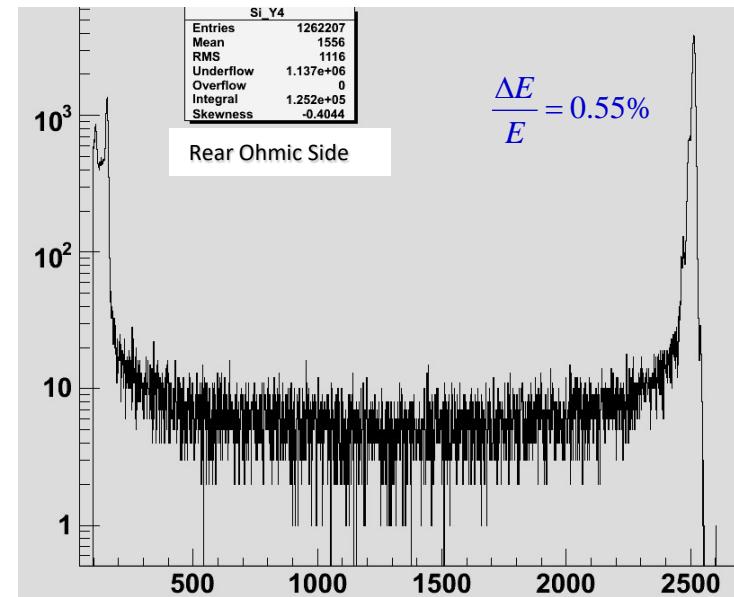
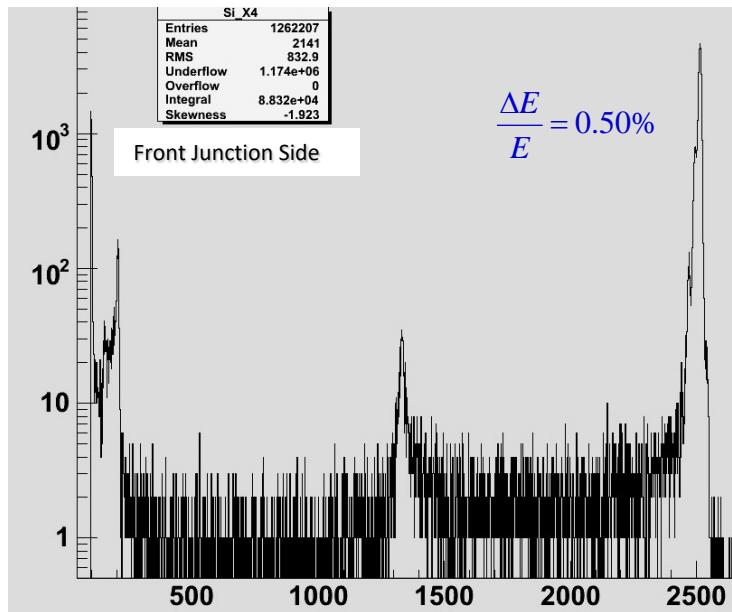
Price: 5094 €

MRC-1
rc master controller
for STM-16

Price: 2200 €

Total cost 22,514.- €

Energy resolution with ^{241}Am source measurement in vacuum



Low energy peak from gap events at about $\frac{1}{2}$ the full pulse height

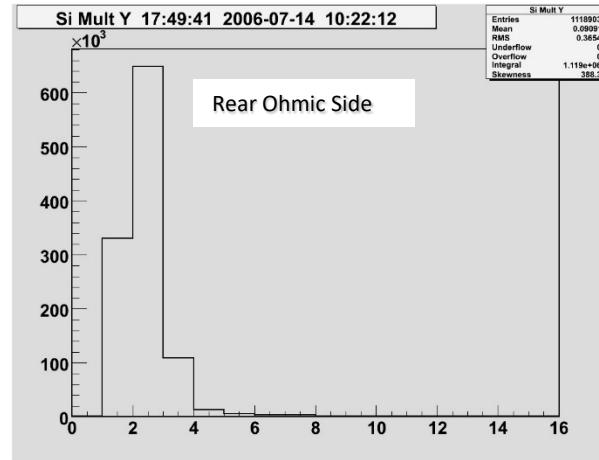
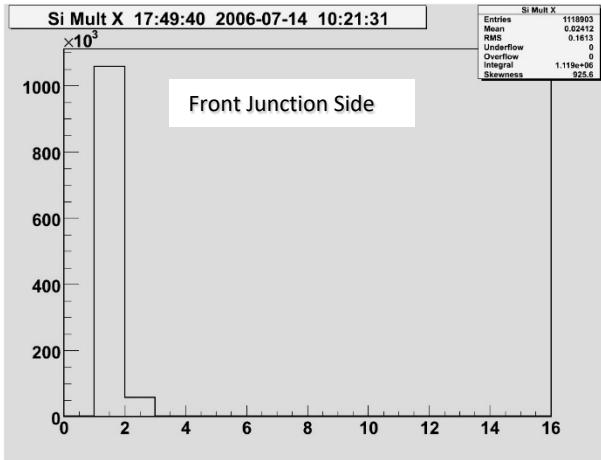
C.Wrede et al. NIM B204 (2003), 619

MICRON #2215-17

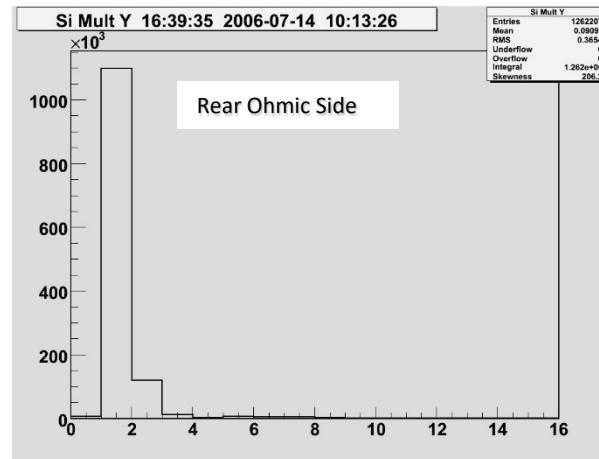
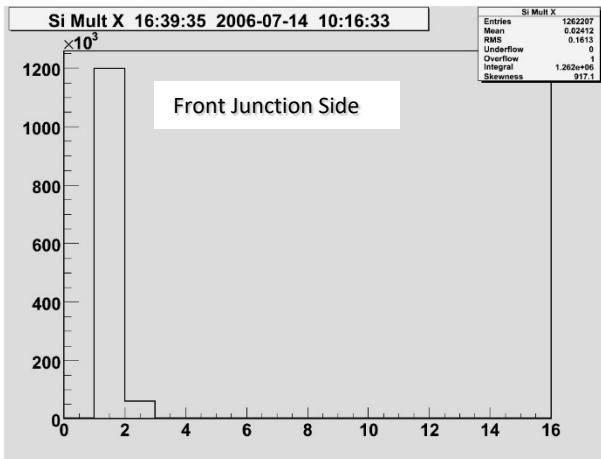
Voltage: 200V

^{241}Am $E_a=5.486 \text{ MeV}$
range $\sim 28 \mu\text{m}$

Strip multiplicity with ^{241}Am source



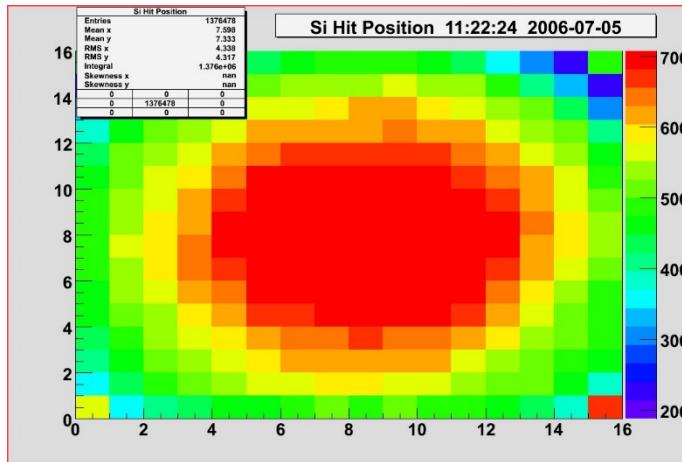
MICRON #2215-17
Voltage: 40V
below full depletion
measurement in vacuum



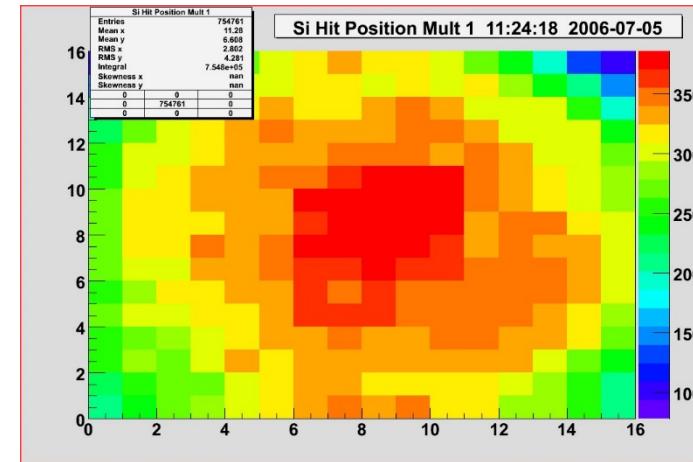
MICRON #2215-17
Voltage: 200V
full depletion voltage
measurement in vacuum

^{241}Am $E_\alpha = 5.486 \text{ MeV}$
range $\sim 28 \mu\text{m}$

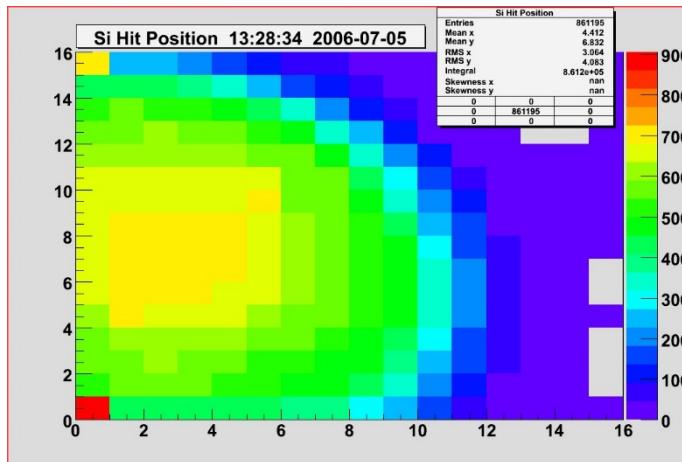
Two dimensional position spectra



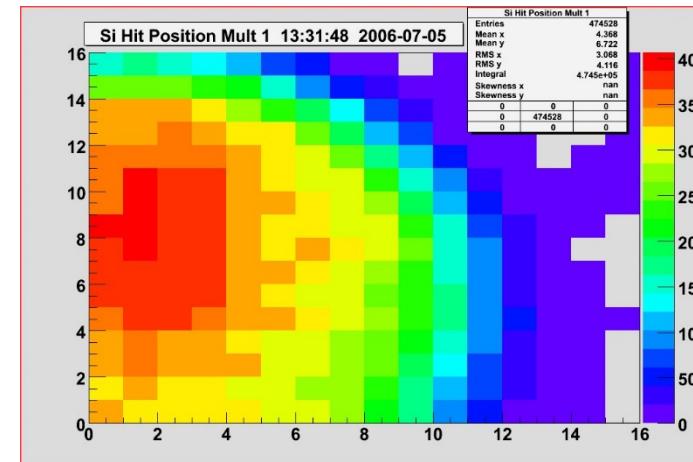
^{241}Am source centered



^{241}Am source centered, strip-multiplicity=1



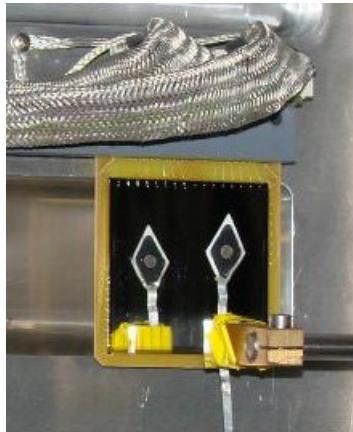
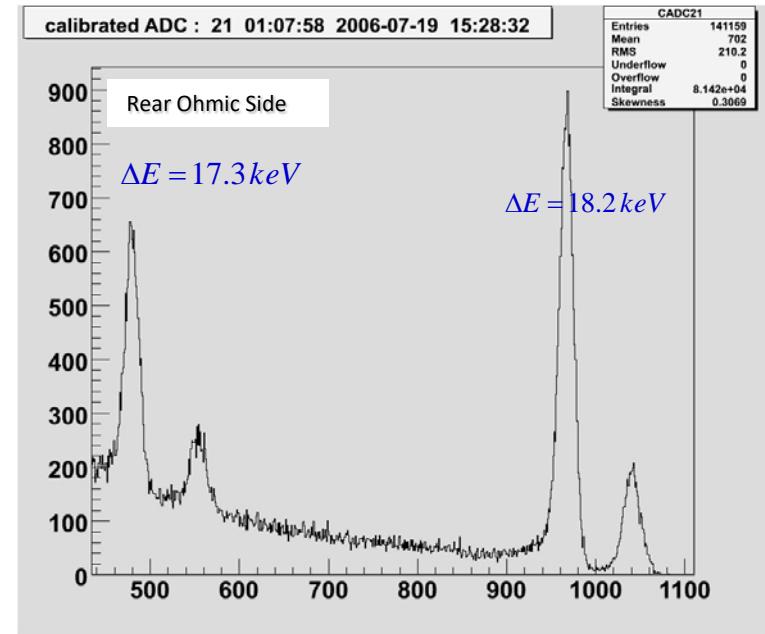
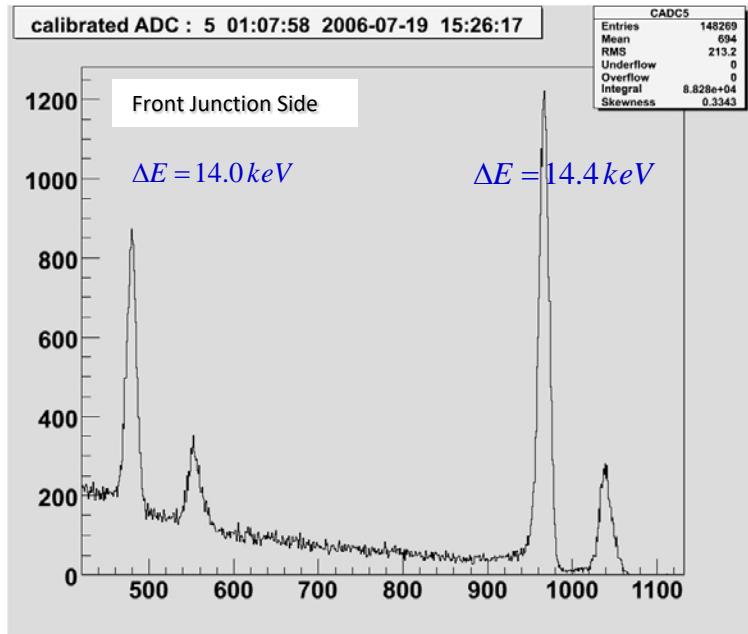
^{241}Am source left



^{241}Am source left, strip-multiplicity=1

MICRON #2243-5 Voltage: 40V, measurement in vacuum

Energy resolution with ^{207}Bi source measurement in vacuum



experimental set-up

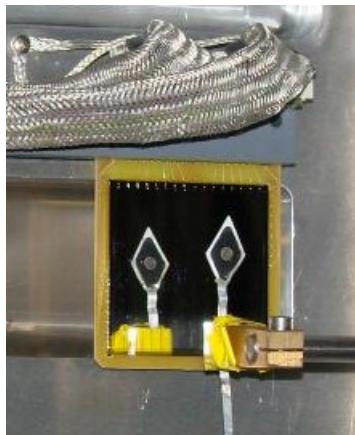
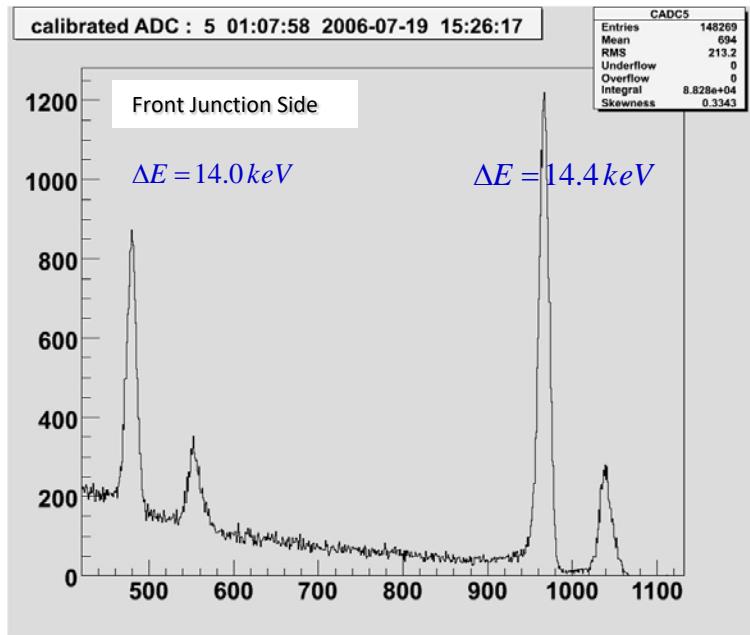
MICRON #2512-17

Voltage: 200V

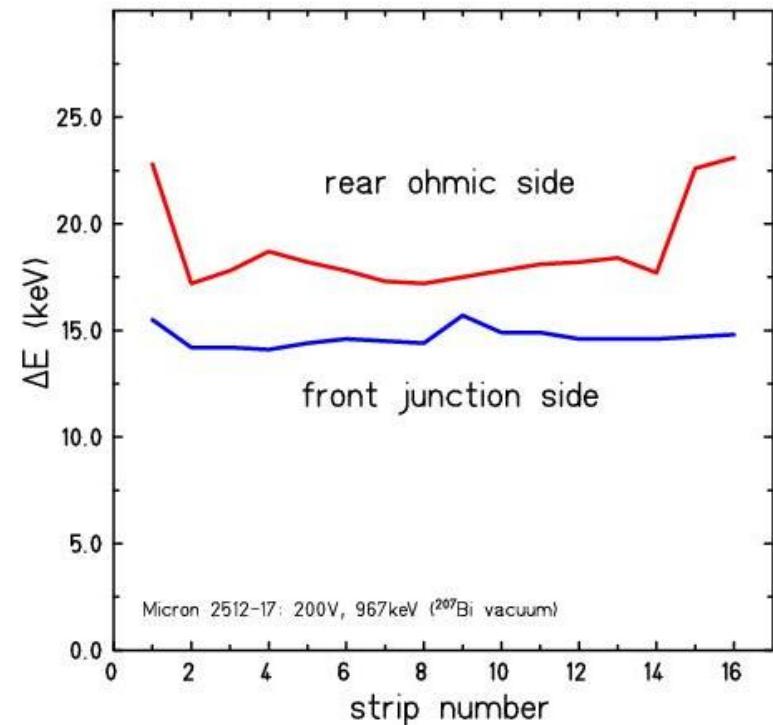
^{207}Bi E=482, 976 keV

range 0.94, 2.31 mm (e⁻e⁻ interaction)

Energy resolution with ^{207}Bi source measurement in vacuum



experimental set-up



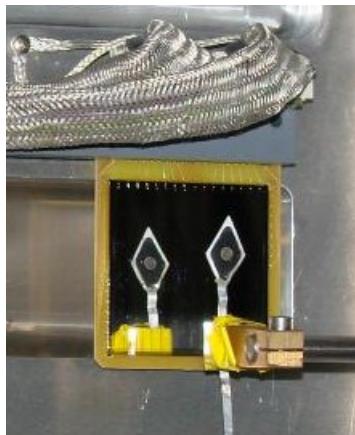
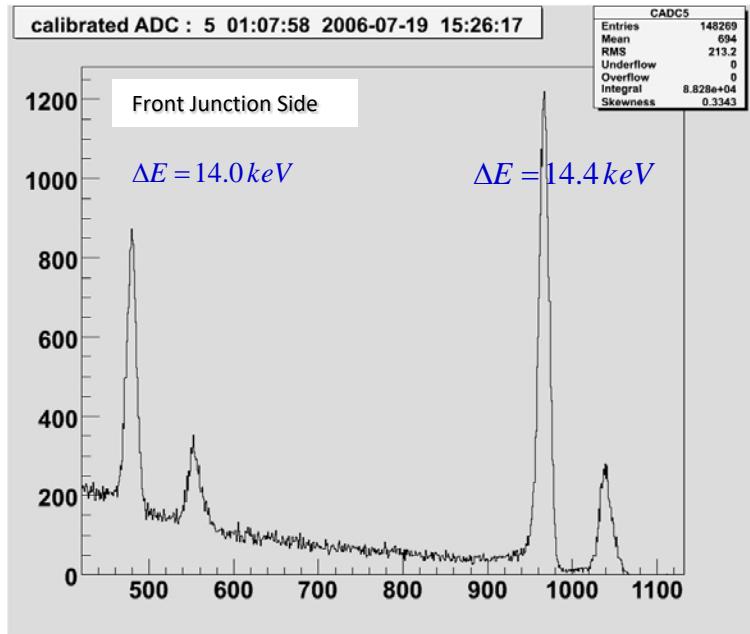
MICRON #2512-17

Voltage: 200V

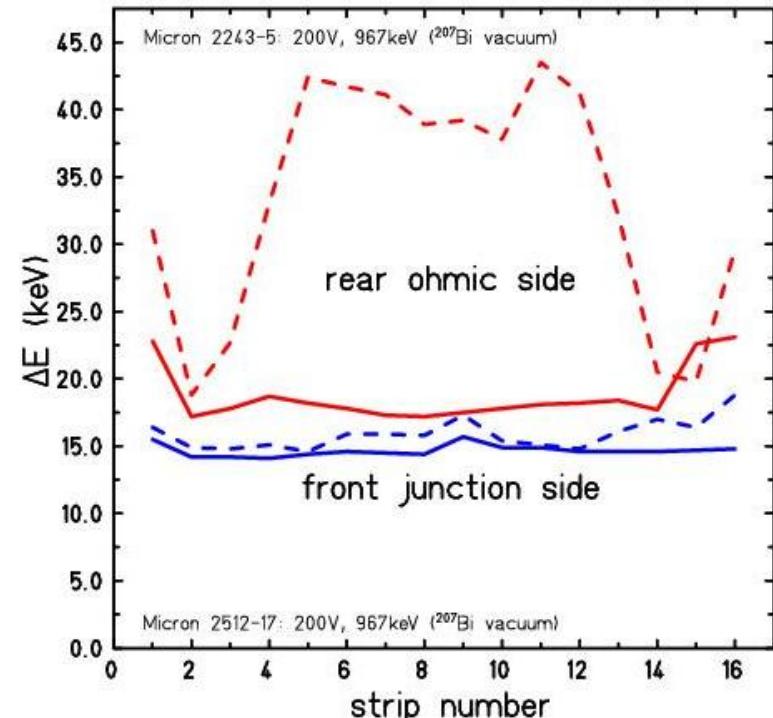
^{207}Bi E=482, 976 keV

range 0.94, 2.31 mm (e⁻e⁻ interaction)

Energy resolution with ^{207}Bi source measurement in vacuum



experimental set-up

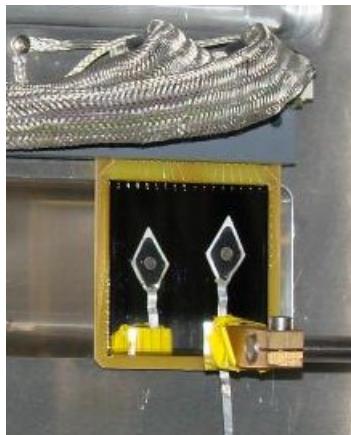
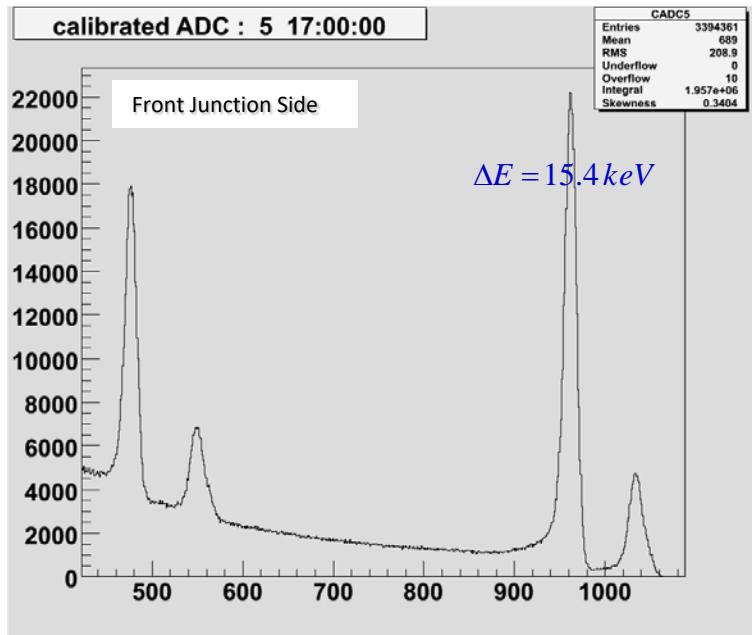


MICRON #2512-17 (full lines)
#2243-5 (dashed lines)

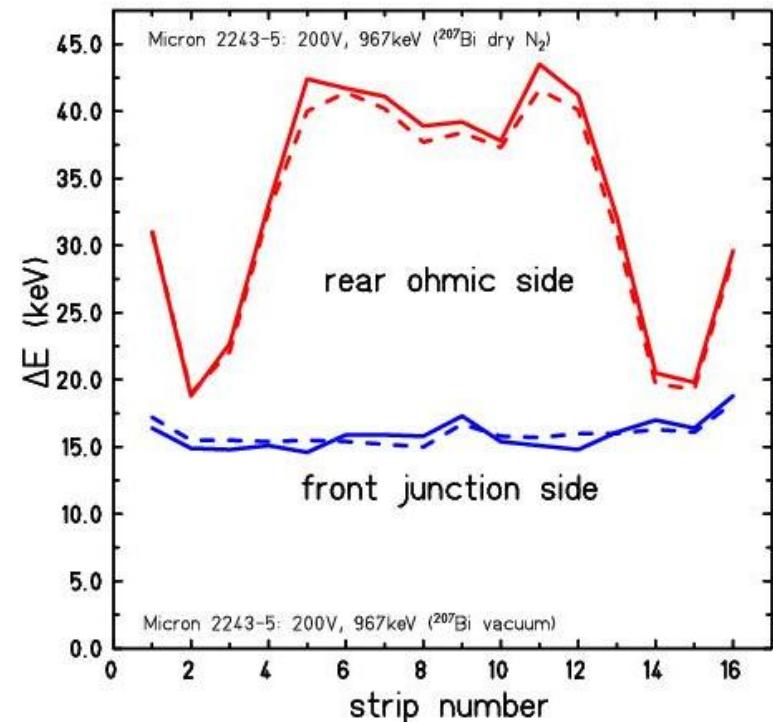
Voltage: 200V

^{207}Bi $E=482, 976 \text{ keV}$
range $0.94, 2.31 \text{ mm} (\text{e}^-\text{e}^- \text{ interaction})$

Energy resolution with ^{207}Bi source measurement in vacuum and dry N₂



experimental set-up



MICRON #2243-5

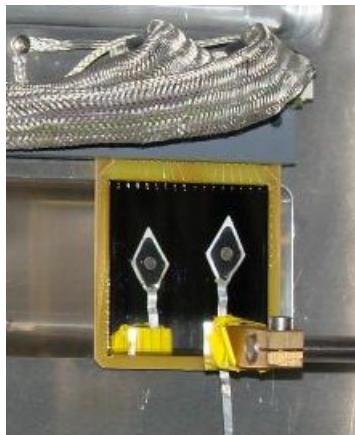
Voltage: 200V

conclusion: measurement in dry N₂

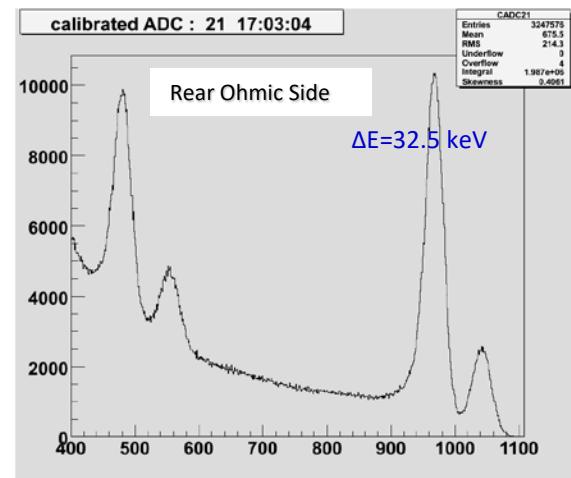
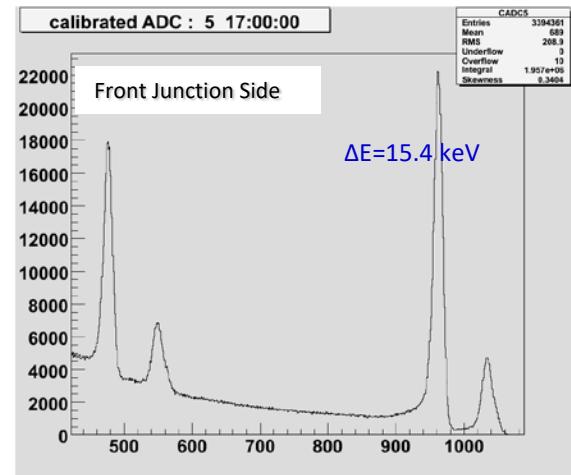
^{207}Bi E=482, 976 keV
range 0.94, 2.31 mm (e⁻e⁻ interaction)

Energy resolution of the DSSSD

MICRON	ΔE (^{241}Am) vacuum	ΔE (^{207}Bi) vacuum	ΔE (^{207}Bi) dry nitrogen
#2243-5	N: 31.3 keV P: 33.3 keV	N: 16.2 keV P: 16.0 keV	
#2243-4	N: 30.2 keV	N: 18.5 keV	
#2243-3	N: 34.0 keV	N: 18.2 keV	
#2243-2	N: 35.7 keV P: 27.0 keV	N: 14.5 keV P: 18.8 keV	
#2512-17	N: 27.4 keV P: 29.7 keV	N: 14.8 keV P: 18.8 keV	

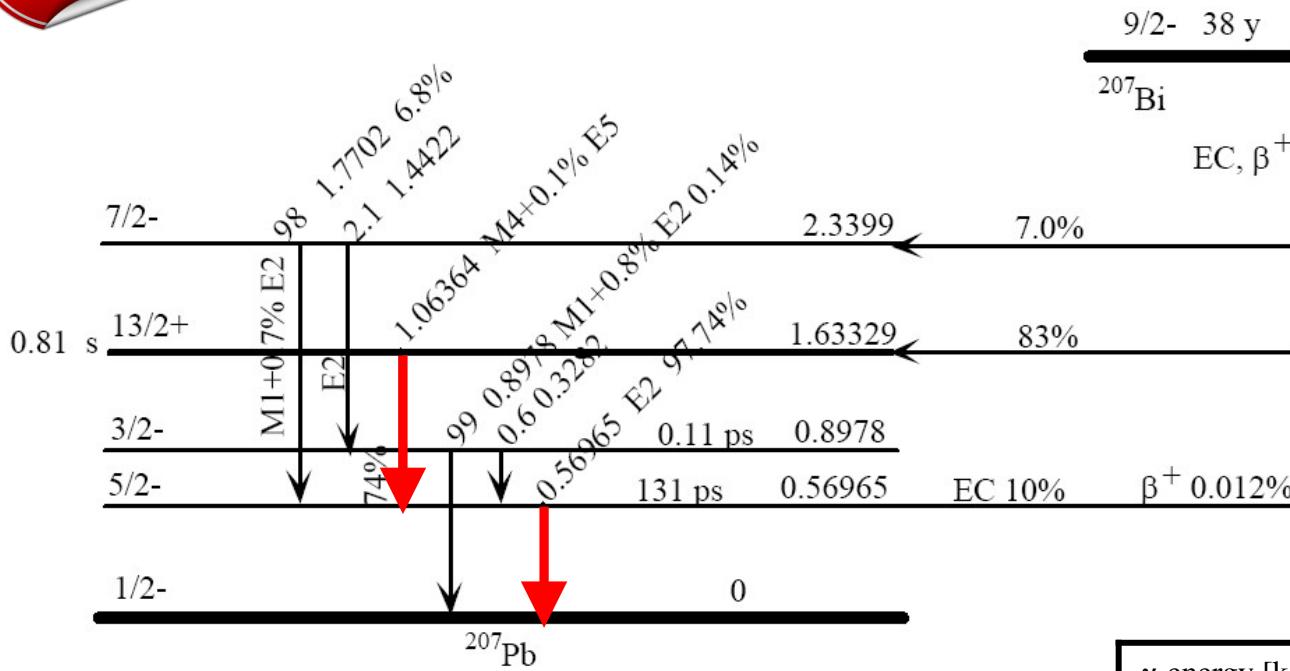


experimental set-up



^{207}Bi $E_e = 976 \text{ keV}$; ^{241}Am $E_\alpha = 5.486 \text{ MeV}$

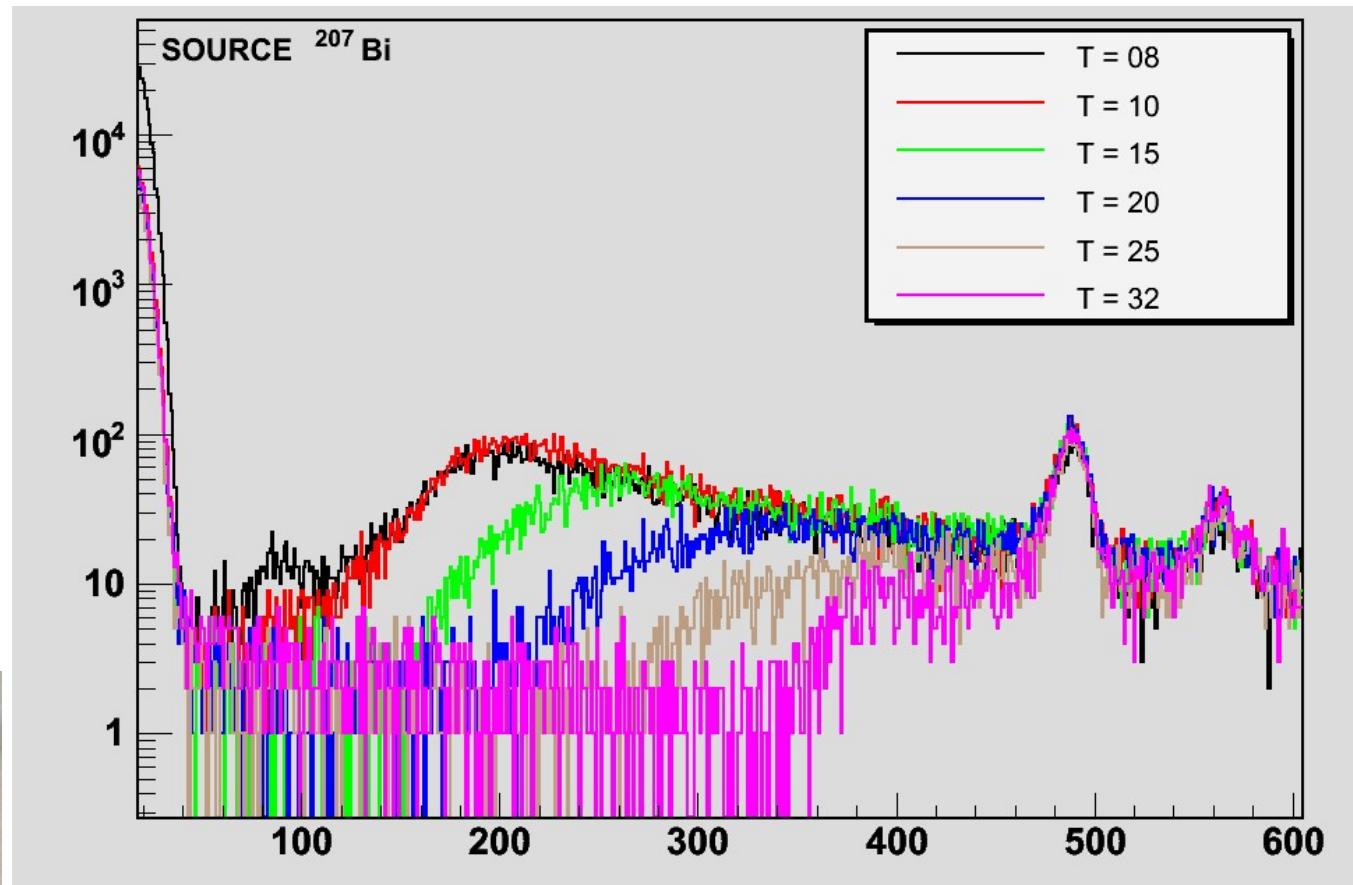
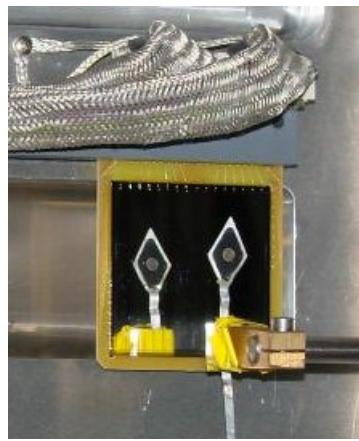
RISING: Test of the active stopper



^{207}Bi emits gamma rays and electrons

γ -energy [keV]	e ⁻ -energy
569.6	481.7 [K]
	553.8-556.7 [L]
	565.8-567.2 [M]
1063.7	975.7 [K]
	1047.8-1050.6 [L]
	1059.8-1061.2 [M]

Energy threshold of the DSSSD



experimental set-up

^{207}Bi $E_e = 482, 976 \text{ keV}$

Measurements with a double-sided Si-strip detector 2006

Rear Ohmic Side



Micron Semiconductor

Nº Junction Elements: 16
Nº Junction Elements: 16
Element Length: 49.5 mm
Element Pitch: 3.1 mm
Element width: 3.0 mm
Active Area: 50x50 mm²
Thickness: 1000 µm

Price: 5600 €

multichannel*
systems



CAEN



CAEN



CPA-16
Charge Sensitive Preamplifier

16 channel compact module
2 output stages with different gains
Bias voltage up to ±500V

Price: 2x 2250 €

Amplifier N 568BC

16 fold shaper

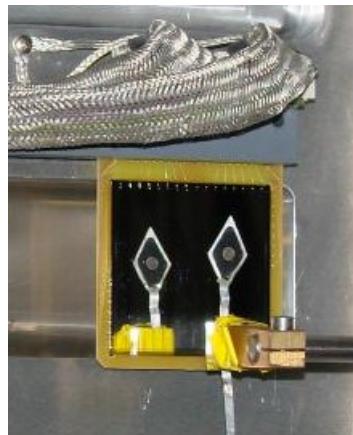
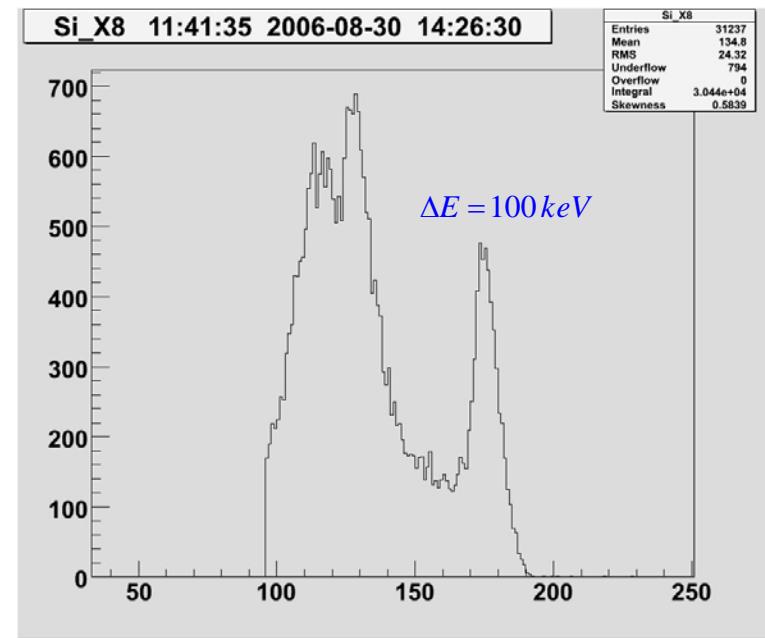
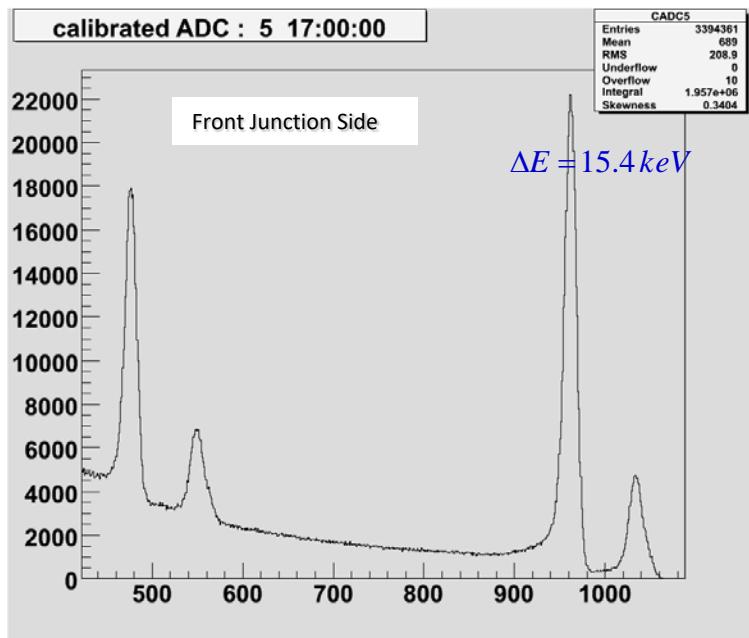
Price: 2x 3481 €

ADC V785AF
32 channel

Price: 2x 5094 €

Total cost 27,250.- €(discriminator not included)

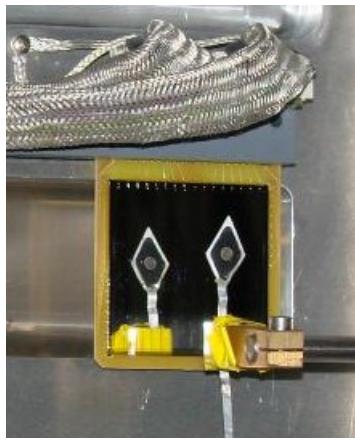
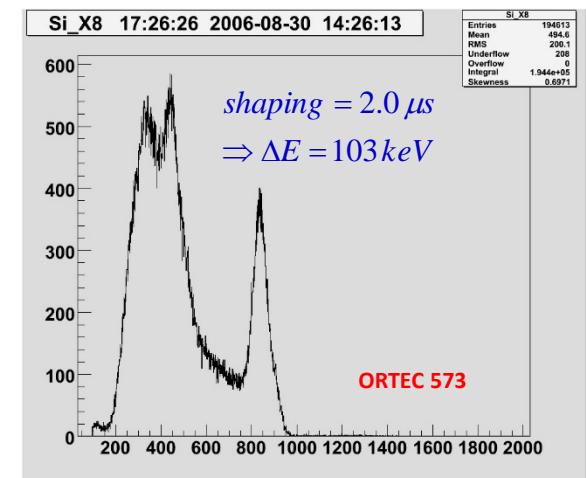
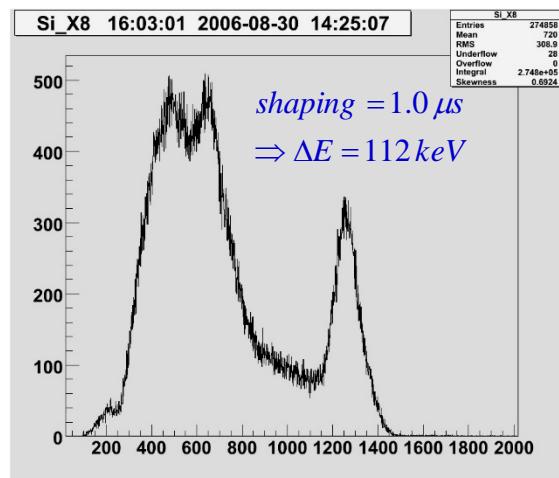
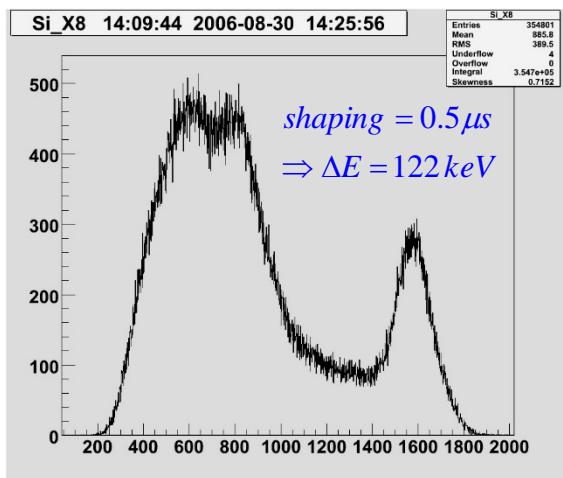
Energy resolution with ^{207}Bi source measurement with Mesytec and Multichannel Systems



MICRON #2243-5
Voltage: 200V
measurement in vacuum

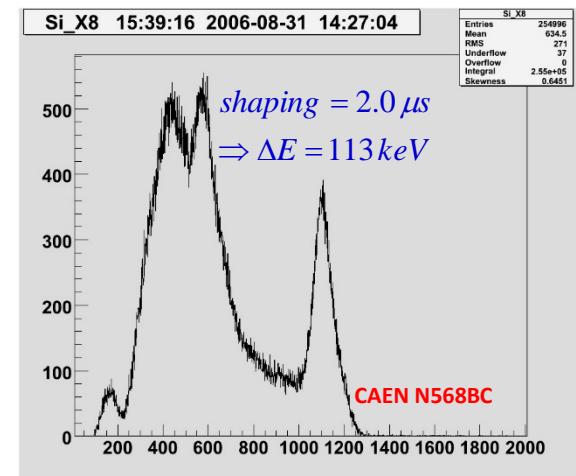
ORTEC 572
shaping time 0.5 μs $\Delta E = 122 \text{ keV}$
1.0 μs $\Delta E = 112 \text{ keV}$
2.0 μs $\Delta E = 103 \text{ keV}$

Energy resolution with ^{207}Bi source measurement with Multichannel Systems



MICRON #2243-5
Voltage: 200V
measurement in vacuum

experimental set-up



Active catcher for implantation-decay correlations

Implantation-decay correlations with large background
(half lifes similar to the implantation rate):

- ✓ implantation-decay time correlation: active catcher
- ✓ implantation-decay position correlation: granularity
- ✓ implantation of several ions: thickness and area
- ✓ energy of the implanted ion and the emitted β



3 double-sided silicon-strip detectors

- surface $5 \times 5 \text{ cm}^2$
- thickness 1 mm
- $2 \times 16 \text{ } 3.125 \text{ mm}$ strips
- manufactured by MICRON



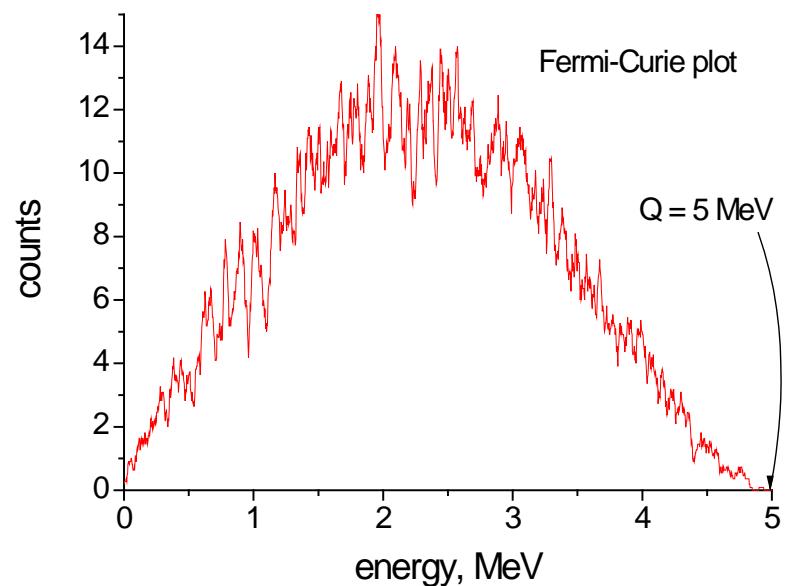
Double-sided silicon-strip detector DSSSD

- surface $5 \times 5 \text{ cm}^2$
- thickness 1 mm
- 2×16 3.125 mm strips
- manufactured by MICRON

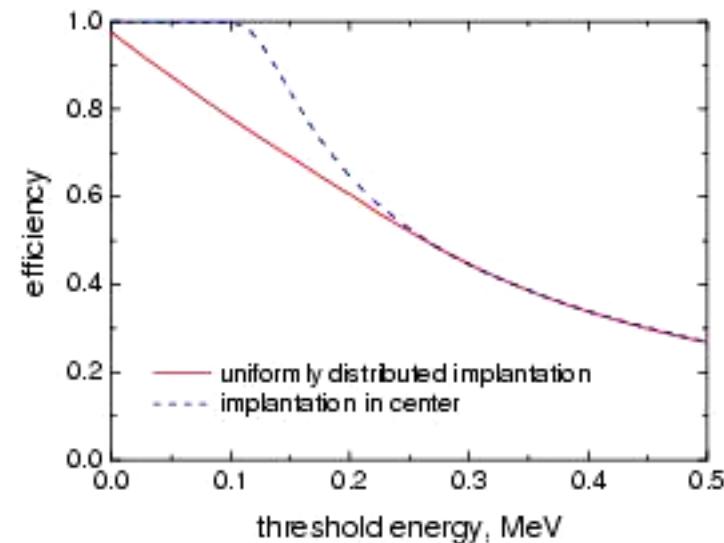
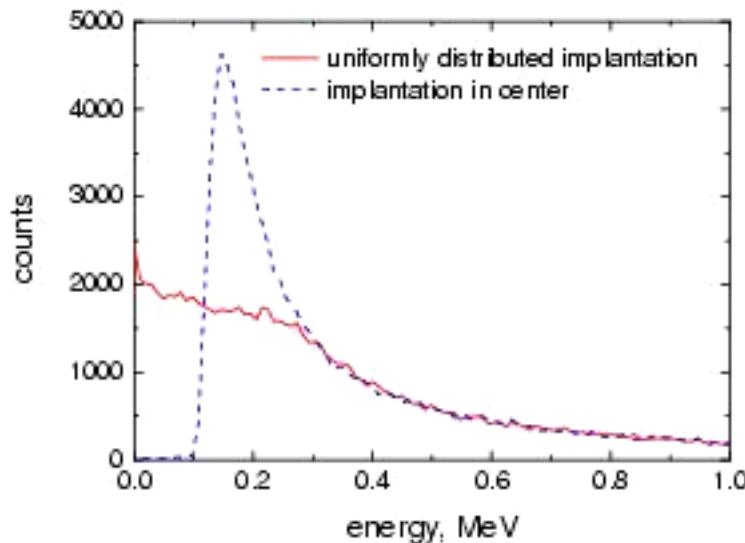


- ✓ thickness sufficient for HI-implantation
- ✓ but range of β -particles larger than 1mm
- ✓ therefore part of the kinetic energy is measured

Monte-Carlo Simulation with GEANT4



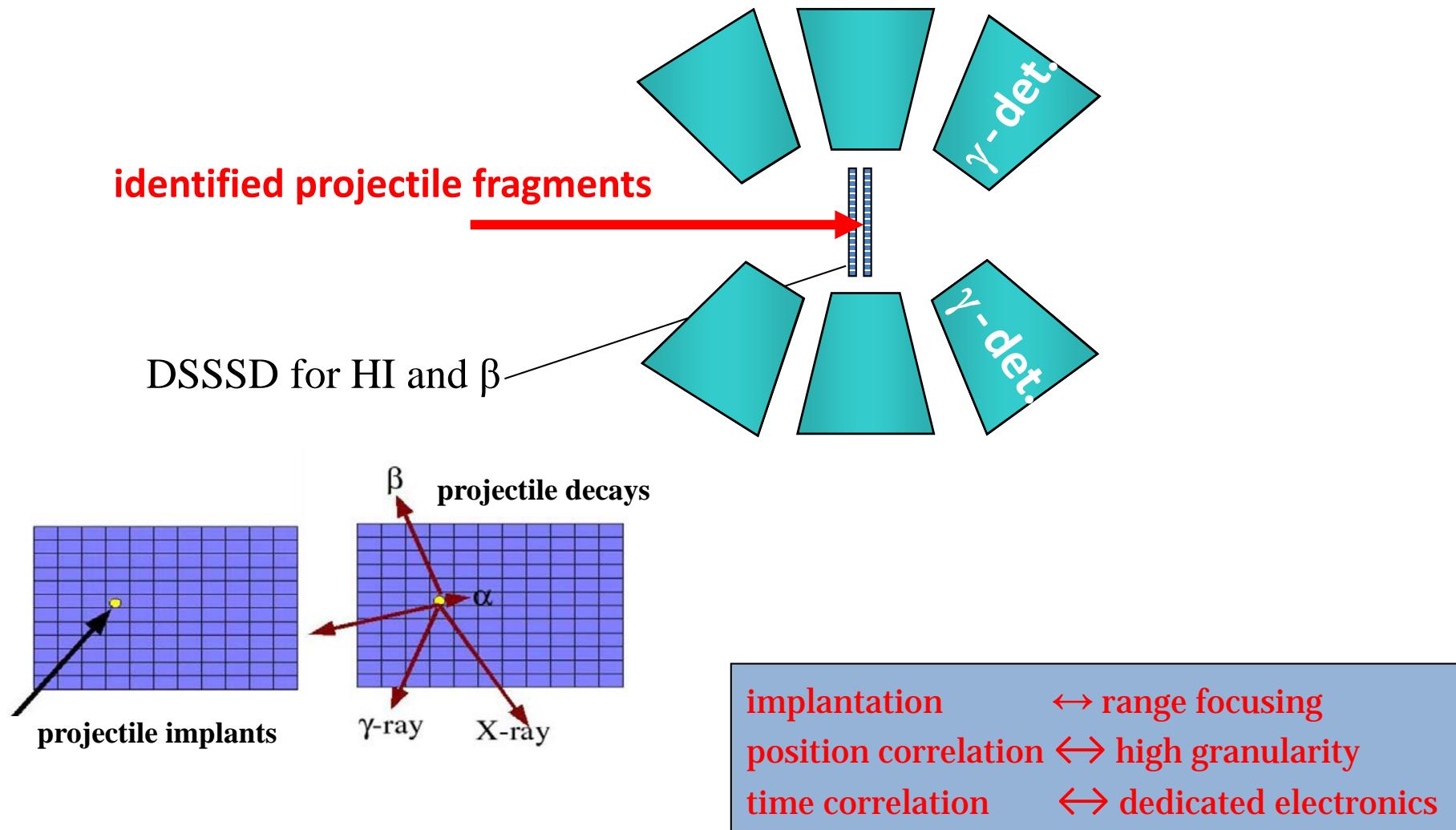
Monte-Carlo simulation with GEANT4



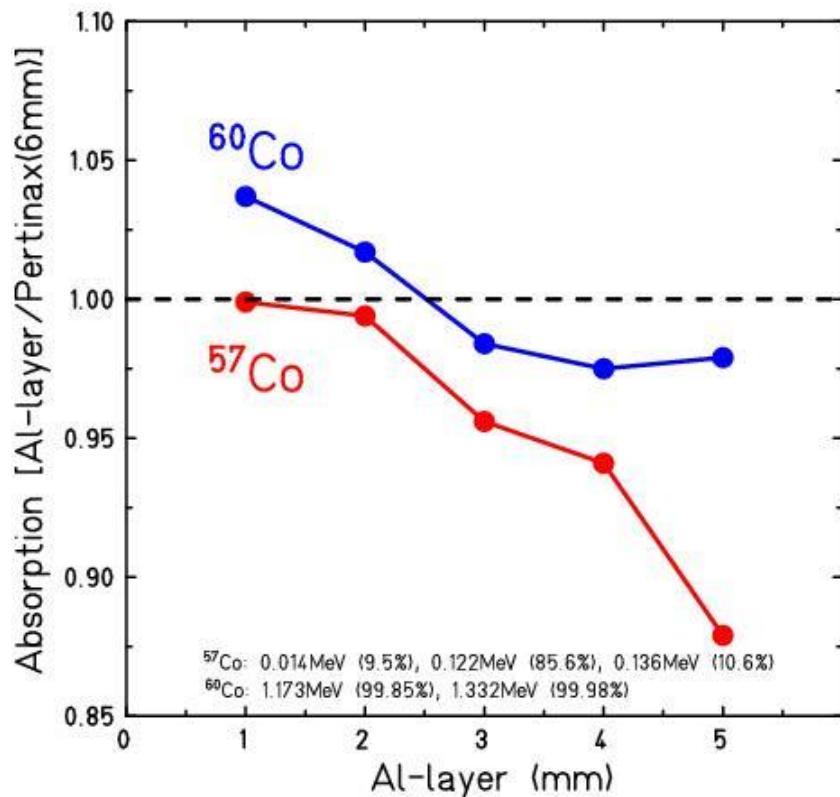
Simulated energy spectrum of β -particles emitted from fragments implanted uniformly (solid line) and exactly in the centre (dashed line) in the middle of a DSSSD.

*Calculated β -detection efficiency as a function of the DSSSD threshold for the two considered implantation scenarios
Detection threshold should be less than 100 keV*

Rare ISotope INvestigation at GSI spectroscopy of stopped beams



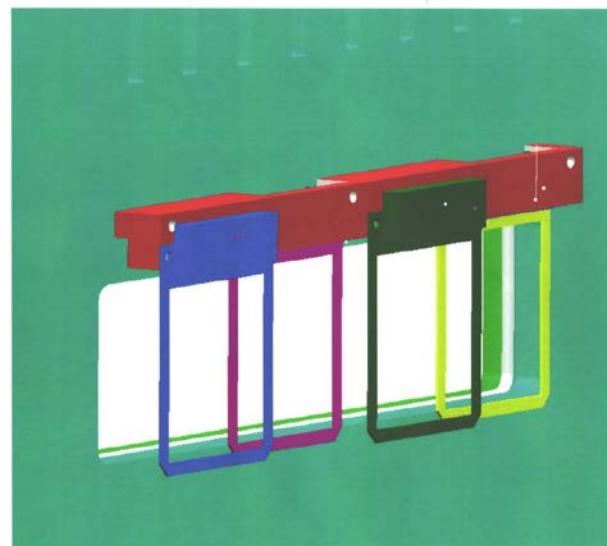
Chamber for active stopper measurement with dry N₂



result:

6mm Pertinax \approx 2mm Al

2mm Pertinax for active stopper chamber

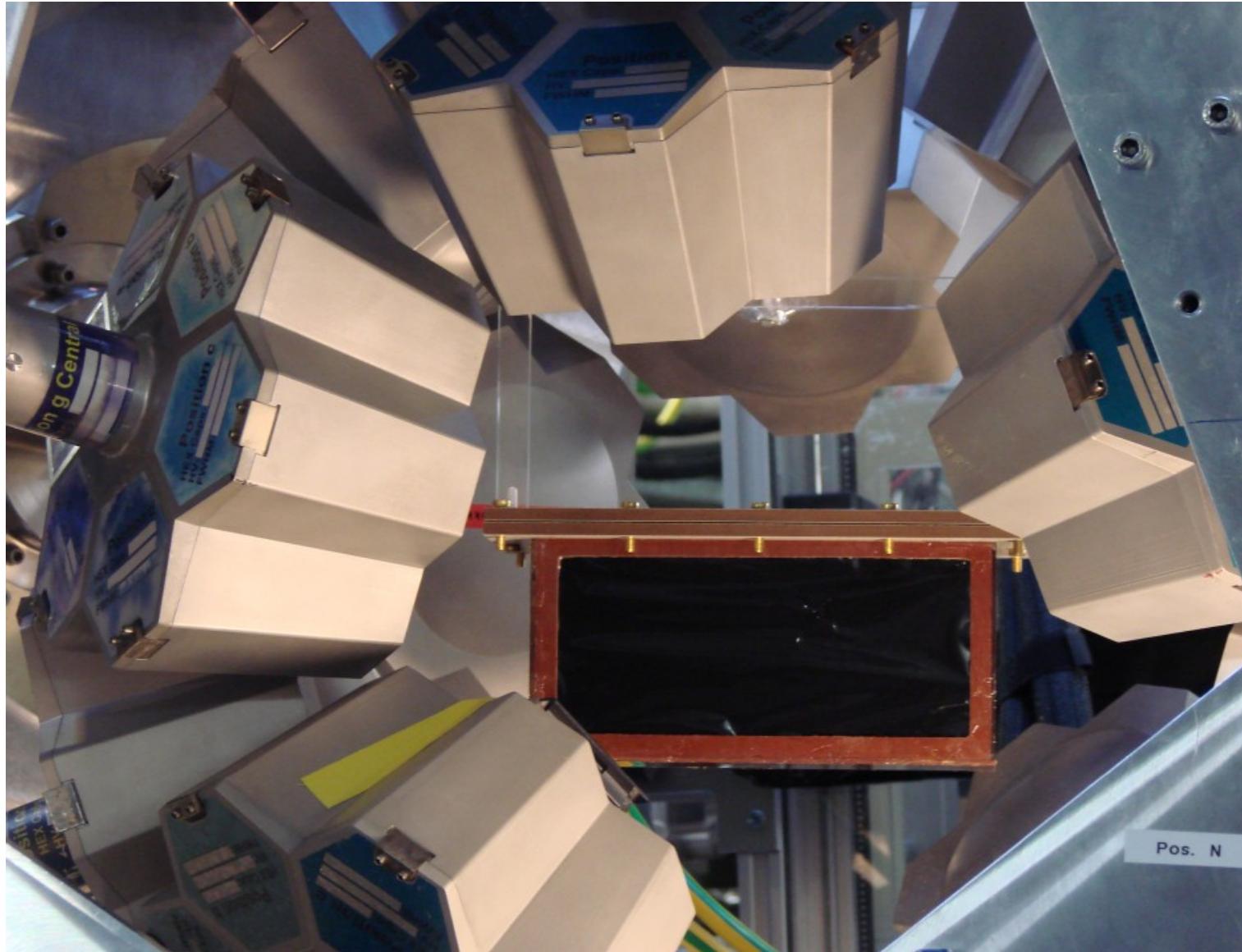


Pertinax

phenolic-formaldehyd cellulose-paper
PF CP 2061



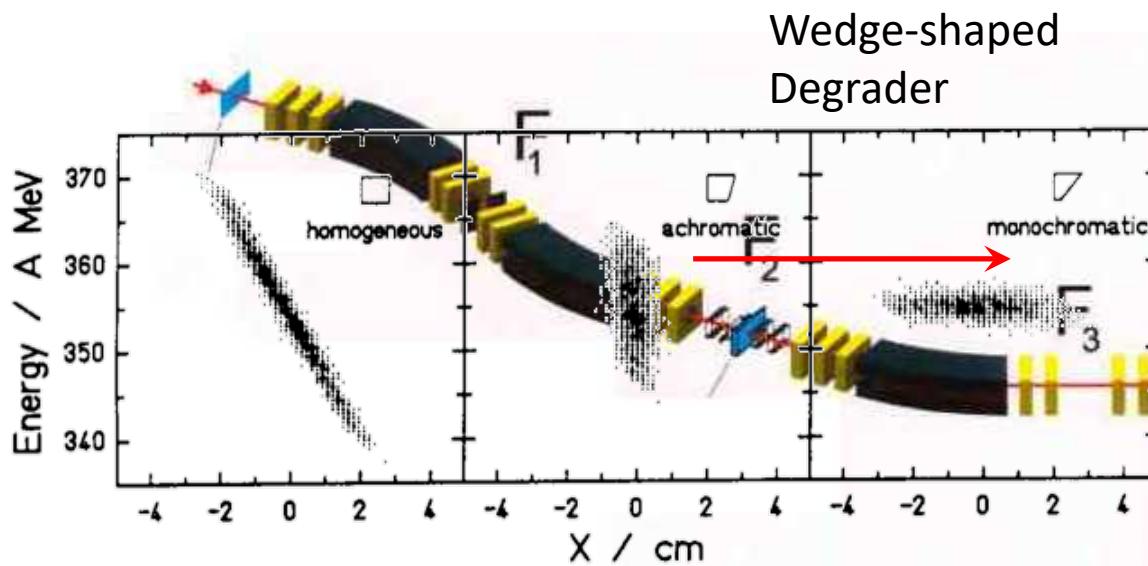
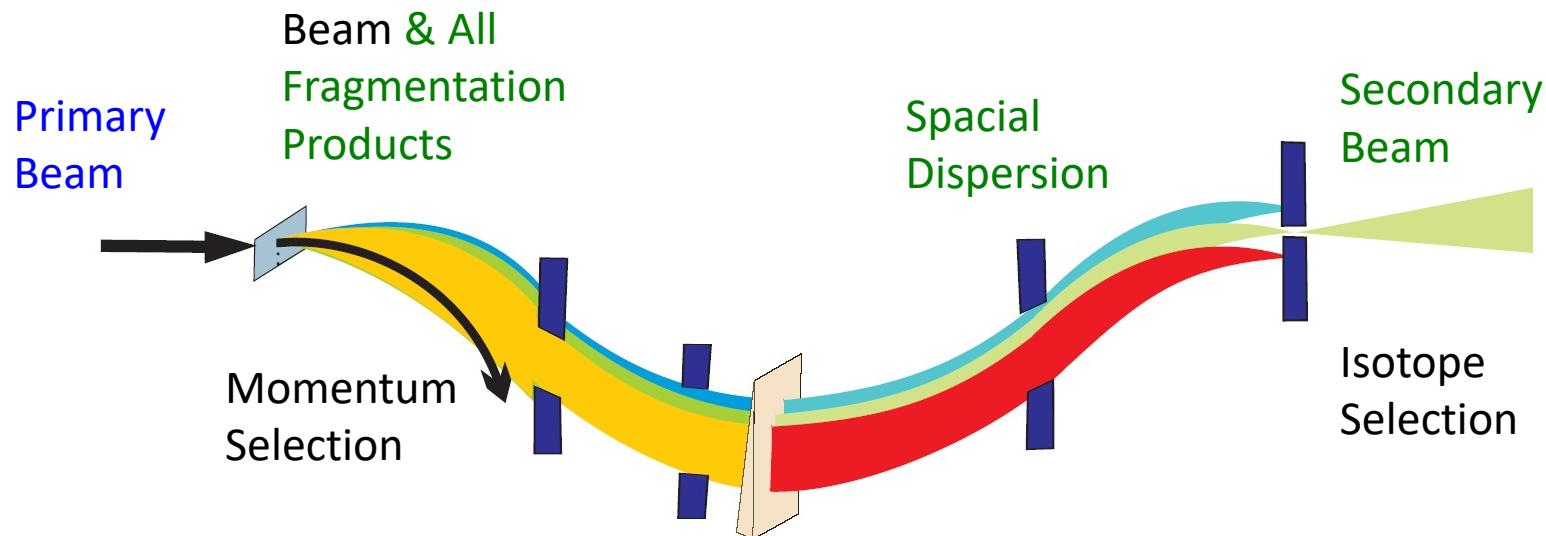
Stopped RISING array @ GSI: 15x7 element Cluster with DSSD



Count rate limitations with active stopper

- $3 \times 16 \times 16 = 3 \times 256 = 768$ total pixels.
 - Assume upper limit for β -half-life of ~ 30 seconds
 - Each pixel hit every 5 half-lives (150 s)
- Max. rate of $\sim 768/150 = 5$ per sec (= 50 per 10s spill).
- Rate increases directly with decreasing half-life
- (e.g., $T_{1/2} = 10$ seconds $\rightarrow 150$ per 10 s spill cycle)
- Dual gain pre-amps on DSSSD to get energies of implanted ion and β -particle
- All events time stamped with MHz clock.

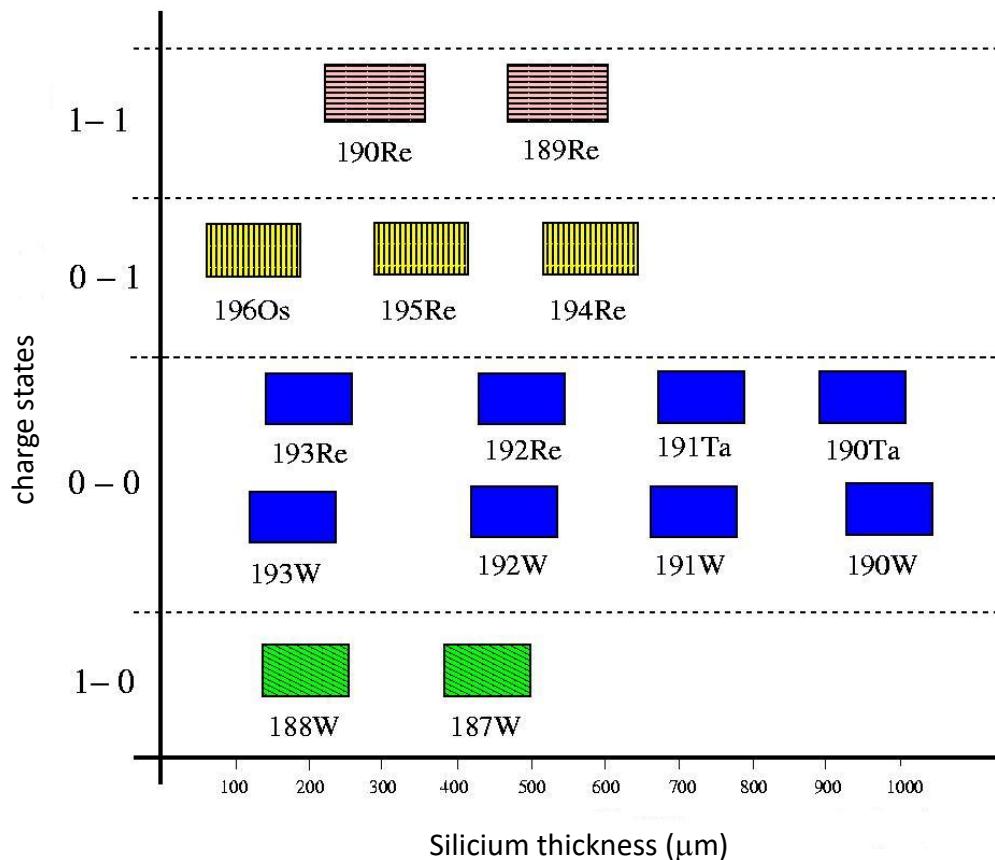
Fragment separator FRS



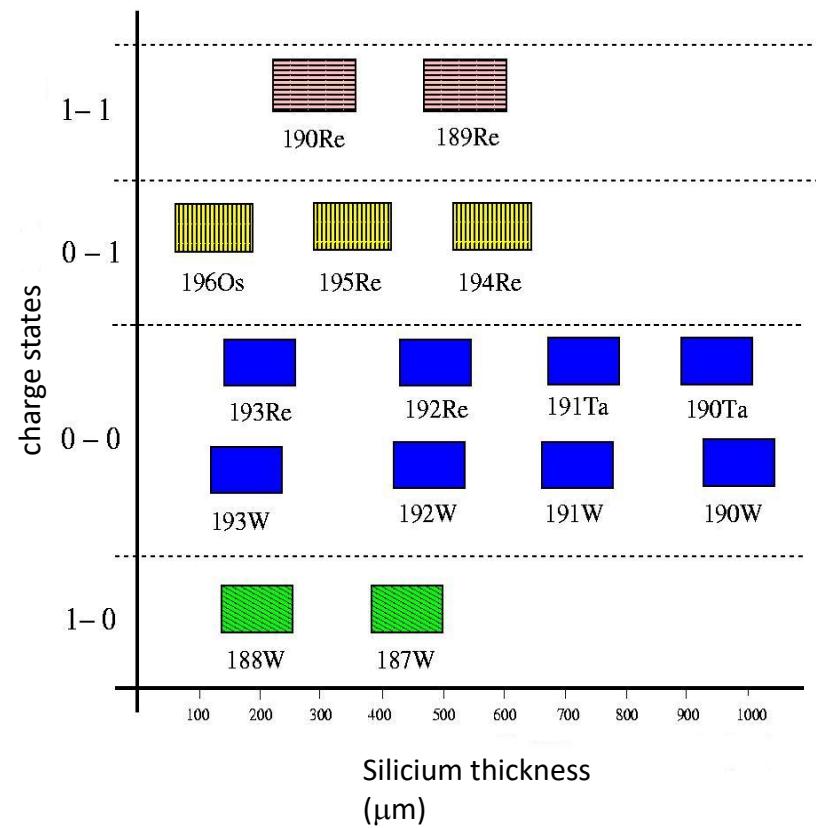
¹⁹Ne at 600AMeV:
Phase-space imaging of differently shaped degraders within the achromatic ion-optical system. The results for a **homogeneous**, an **achromatic**, and a **monoenergetic** degrader are given. All degraders have the same thickness on the optical axis ($d/r=0.5$)

Implantation range

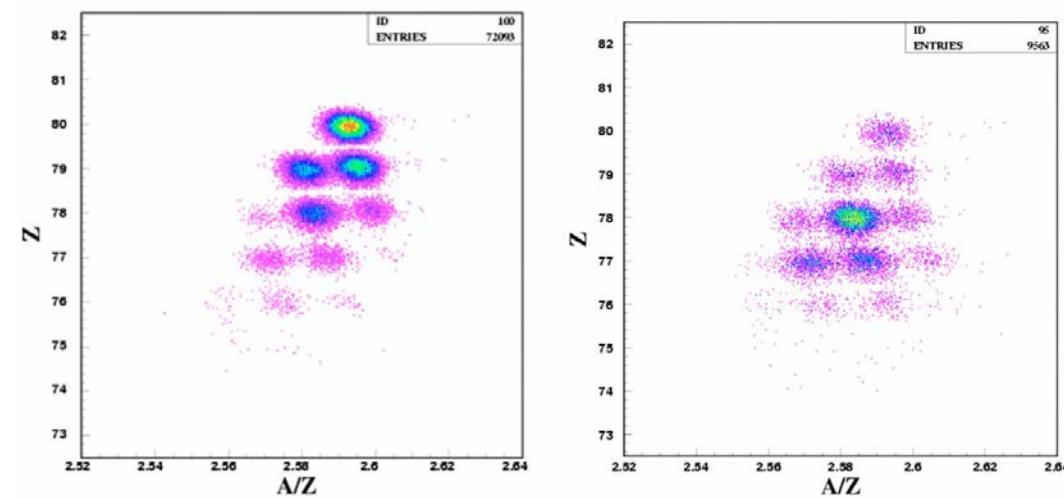
Estimated implanted isotopes for a setting centered on ^{192}W
in 1 mm thickness silicon with a **monoenergetic degrader at S2**



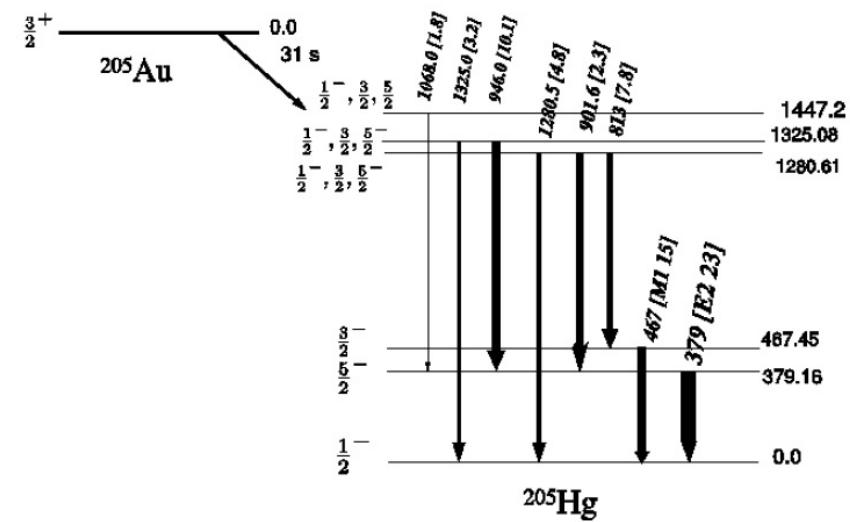
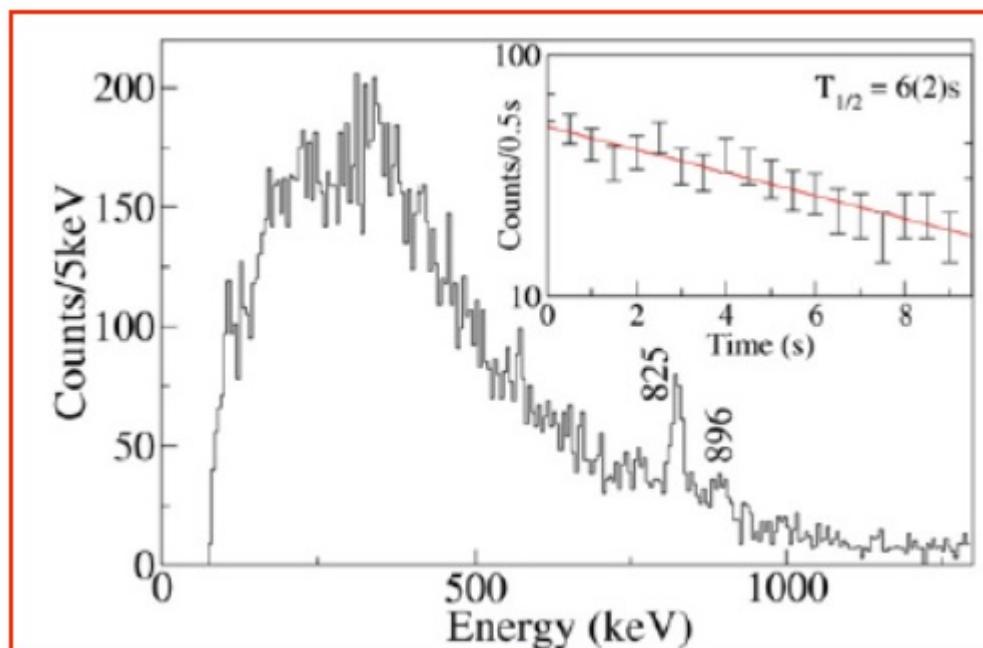
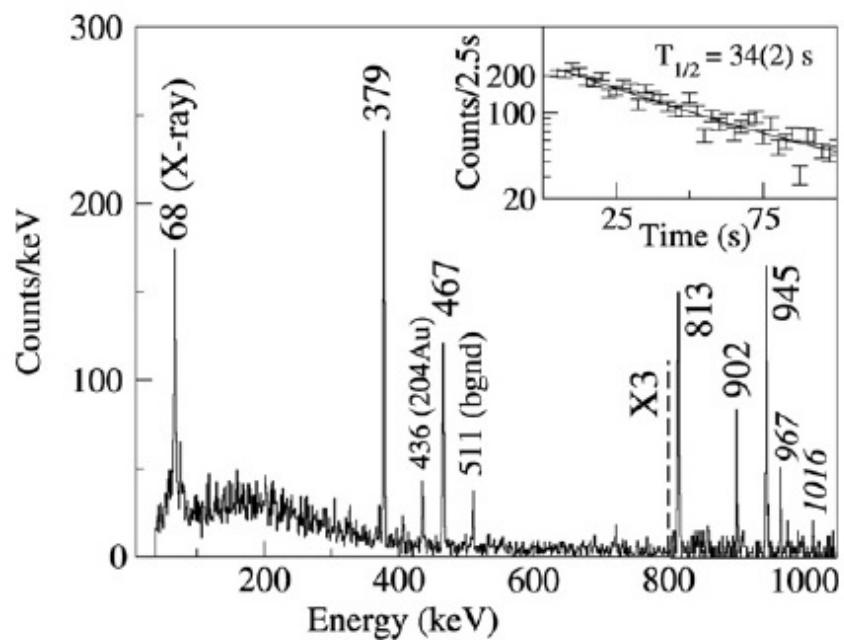
Estimated implanted isotopes for a setting centered on ^{192}W in 1mm thickness silicon with a monoenergetic degrader at S2



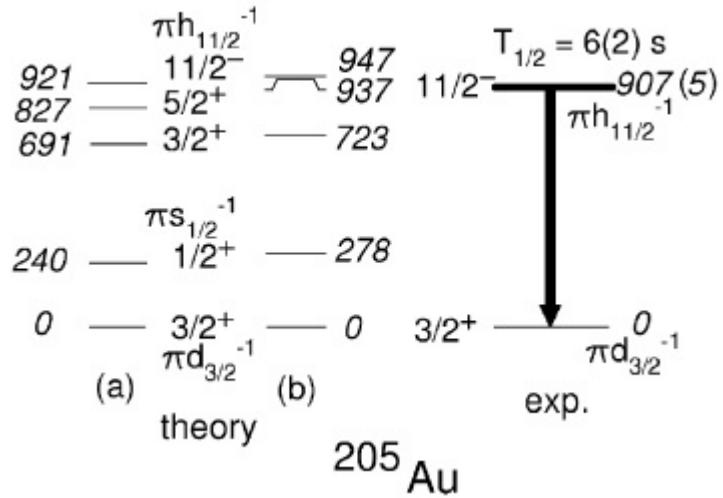
Setting centered on ^{198}Ir
produced implanted



Experimental results conversion electrons

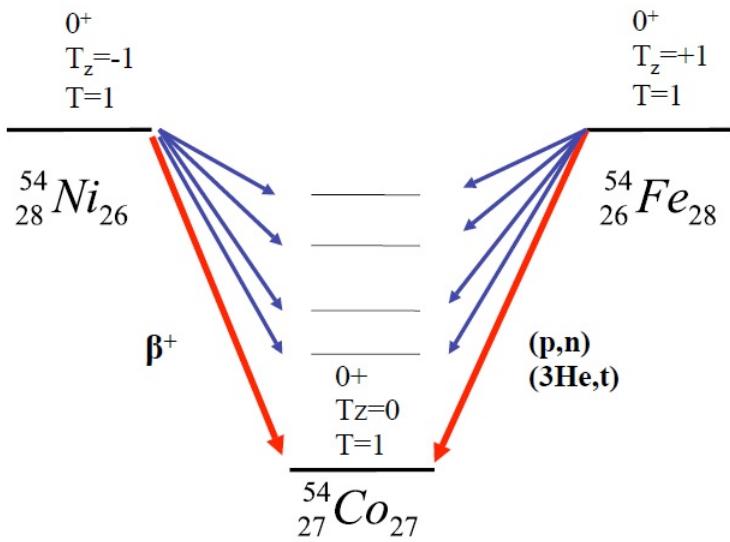


Zs. Podolyak, Phys. Lett B672 (2009), 116



proton-hole excitation in the closed shell nucleus ^{205}Au

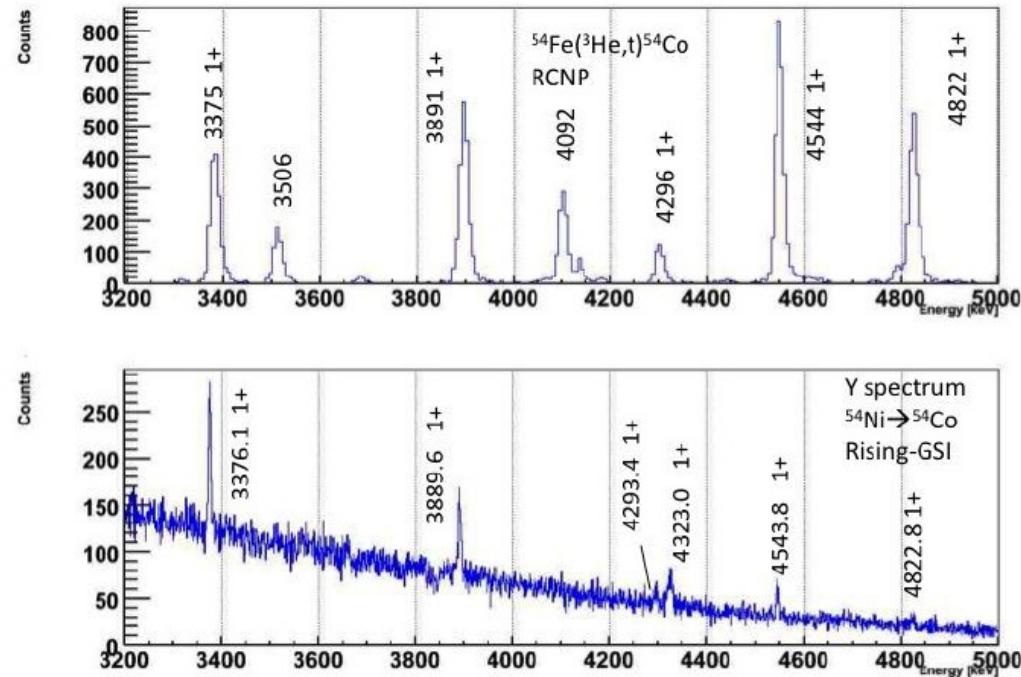
Experimental results beta decay



Y. Fujita et al.
PRL 95 (2005)

$$\frac{1}{T_{1/2}} = \frac{1}{t_{Fermi}} + \sum_{i=GT} \frac{1}{t_i}$$

From β -decay B(F)=N-Z From (3He,t)



$T_z-1 \rightarrow T_z=0$ GT transition (β -decay)